

HiPerFET™ Power MOSFETs

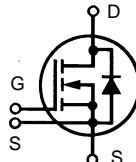
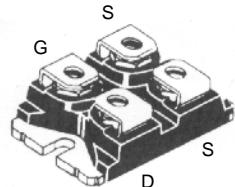
Single Die MOSFET

IXFN 26N90
IXFN 25N90

V_{DSS}	I_D (cont)	R_{DS(on)}	t_{rr}
900 V	26 A	0.30 Ω	250 ns
900 V	25 A	0.33 Ω	250 ns

N-Channel Enhancement Mode
Avalanche Rated, High dv/dt, Low t_{rr}

Preliminary data sheet


miniBLOC, SOT-227 B (IXFN)
 **E153432**

G = Gate D = Drain
S = Source

Either Source terminal at miniBLOC can be used as Main or Kelvin Source

Symbol	Test Conditions	Maximum Ratings		
V_{DSS}	T _J = 25°C to 150°C	900	V	
V_{DGR}	T _J = 25°C to 150°C; R _{GS} = 1 MΩ	900	V	
V_{GS}	Continuous	±20	V	
V_{GSM}	Transient	±30	V	
I_{D25}	T _C = 25°C	26N90	26	A
		25N90	25	
I_{DM}	T _C = 25°C, pulse width limited by T _{JM}	26N90	104	A
		25N90	100	
I_{AR}	T _C = 25°C	26N90	26	A
		25N90	25	
E_{AR}	T _C = 25°C	64	mJ	
E_{AS}	T _C = 25°C	3	J	
dv/dt	I _S ≤ I _{DM} , di/dt ≤ 100 A/μs, V _{DD} ≤ V _{DSS} , T _J ≤ 150°C, R _G = 2 Ω	5	V/ns	
P_D	T _C = 25°C	600	W	
T_J		-55 ... +150	°C	
T_{JM}		150	°C	
T_{stg}		-55 ... +150	°C	
T_J	1.6 mm (0.63 in) from case for 10 s	-	°C	
V_{ISOL}	50/60 Hz, RMS t = 1 min	2500	V~	
	I _{ISOL} ≤ 1 mA t = 1 s	3000	V~	
M_d	Mounting torque	1.5/13	Nm/lb.in.	
	Terminal connection torque	1.5/13	Nm/lb.in.	
Weight		30	g	

Symbol	Test Conditions	Characteristic Values		
		(T _J = 25°C, unless otherwise specified)		
		min.	typ.	max.
V_{DSS}	V _{GS} = 0 V, I _D = 3 mA	900		V
V_{GH(th)}	V _{DS} = V _{GS} , I _D = 8 mA	3.0	5.0	V
I_{GSS}	V _{GS} = ±20 V _{DC} , V _{DS} = 0		±200	nA
I_{DSS}	V _{DS} = 0.8 • V _{DSS} T _J = 25°C V _{GS} = 0 V T _J = 125°C		100	μA
			2	mA
R_{DS(on)}	V _{GS} = 10 V, I _D = 0.5 • I _{D25} Pulse test, t ≤ 300 μs, duty cycle d ≤ 2 %	26N90 25N90	0.30 0.33	Ω

IXYS reserves the right to change limits, test conditions, and dimensions.

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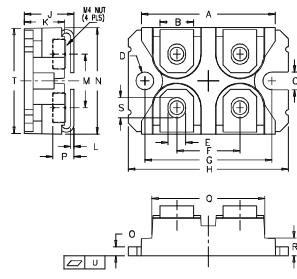
Applications

- DC-DC converters
- Battery chargers
- Switched-mode and resonant-mode power supplies
- DC choppers
- Temperature and lighting controls

Advantages

- Easy to mount
- Space savings
- High power density

Symbol	Test Conditions	Characteristic Values			
		($T_j = 25^\circ\text{C}$, unless otherwise specified)	min.	typ.	max.
g_{fs}	$V_{DS} = 10 \text{ V}; I_D = 0.5 \cdot I_{D25}$, pulse test	18	28	S	
C_{iss} C_{oss} C_{rss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	8.7	10.8	nF	
		800	1000	pF	
		300	375	pF	
$t_{d(on)}$ t_r $t_{d(off)}$ t_f	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 \cdot I_{D25}$ $R_G = 1 \Omega$ (External)	60		ns	
		35		ns	
		130		ns	
		24		ns	
$Q_{g(on)}$ Q_{gs} Q_{gd}	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 \cdot I_{D25}$	240		nC	
		56		nC	
		107		nC	
R_{thJC}			0.21	K/W	
R_{thCK}			0.05	K/W	

miniBLOC, SOT-227 B


M4 screws (4x) supplied

Dim.	Millimeter Min.	Millimeter Max.	Inches Min.	Inches Max.
A	31.50	31.88	1.240	1.255
B	7.80	8.20	0.307	0.323
C	4.09	4.29	0.161	0.169
D	4.09	4.29	0.161	0.169
E	4.09	4.29	0.161	0.169
F	14.91	15.11	0.587	0.595
G	30.12	30.30	1.186	1.193
H	38.00	38.23	1.496	1.505
J	11.68	12.22	0.460	0.481
K	8.92	9.60	0.351	0.378
L	0.76	0.84	0.030	0.033
M	12.60	12.85	0.496	0.506
N	25.15	25.42	0.990	1.001
O	1.98	2.13	0.078	0.084
P	4.95	5.97	0.195	0.235
Q	26.54	26.90	1.045	1.059
R	3.94	4.42	0.155	0.174
S	4.72	4.85	0.186	0.191
T	24.59	25.07	0.968	0.987
U	-0.05	0.1	-0.002	0.004

Source-Drain Diode

Symbol	Test Conditions	Characteristic Values			
		($T_j = 25^\circ\text{C}$, unless otherwise specified)	min.	typ.	max.
I_s	$V_{GS} = 0 \text{ V}$	26N90 25N90		26 25	A
I_{SM}	Repetitive; pulse width limited by T_{JM}	26N90 25N90		104 100	A
V_{SD}	$I_F = I_S, V_{GS} = 0 \text{ V},$ Pulse test, $t \leq 300 \mu\text{s}$, duty cycle $d \leq 2 \%$			1.5	V
t_{rr} Q_{RM} I_{RM}	$I_F = I_S, -di/dt = 100 \text{ A}/\mu\text{s}, V_R = 100 \text{ V}$		1.4 10	250	ns μC A

Figure 1. Output Characteristics at 25°C

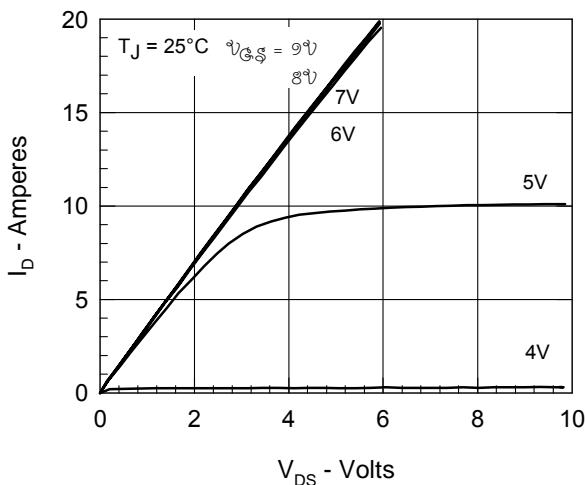


Figure 2. Extended Output Characteristics at 125°C

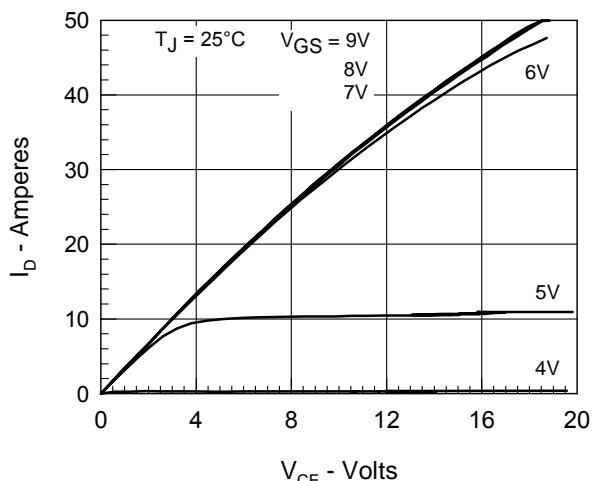


Figure 3. $R_{DS(on)}$ normalized to 0.5 I_{D25} value vs. I_D

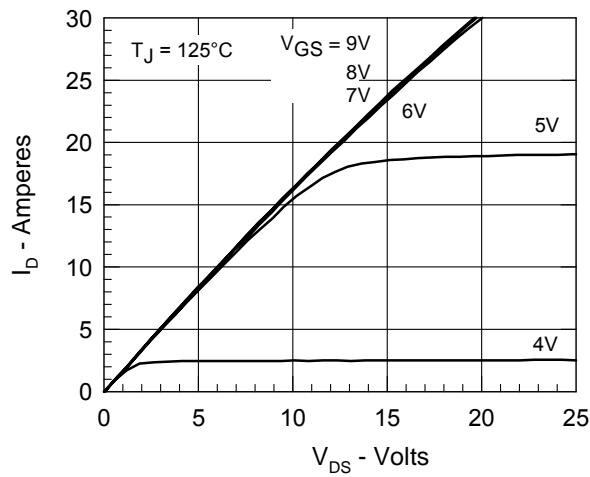


Figure 4. Admittance Curves

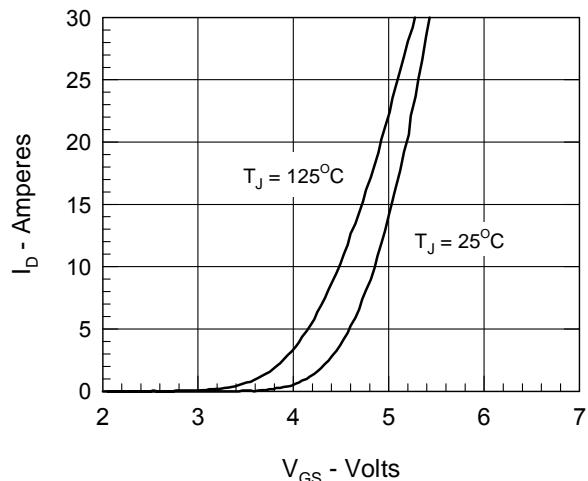


Figure 5. $R_{DS(on)}$ normalized to 0.5 I_{D25} value vs. I_D

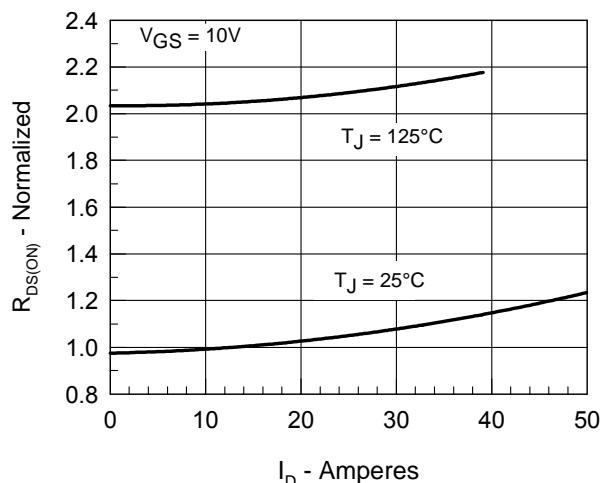


Figure 6. $R_{DS(on)}$ normalized to 0.5 I_{D25} value vs. T_J

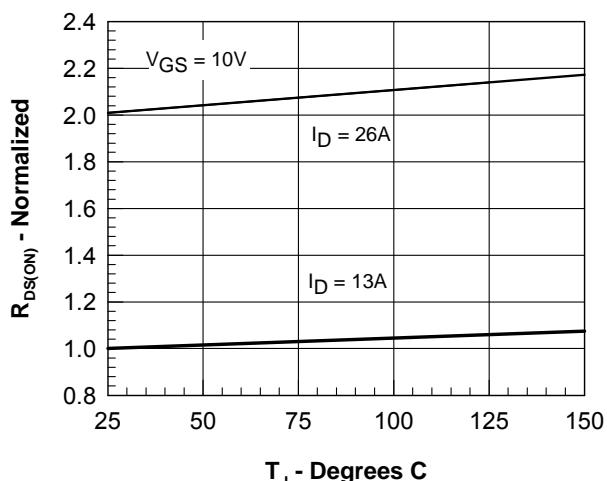


Figure 7. Gate Charge

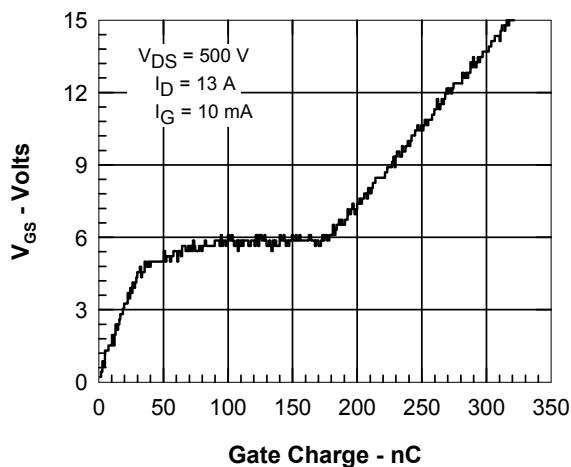
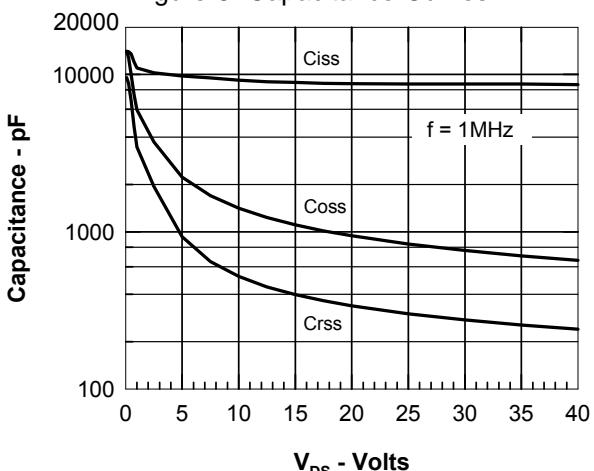


Figure 8. Capacitance Curves



Capacitance Curves

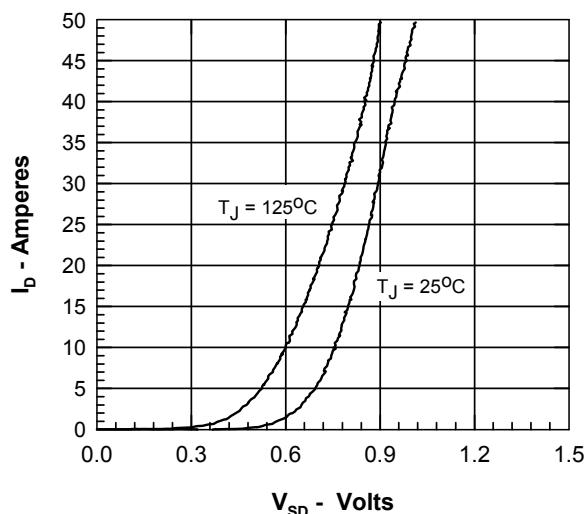


Figure 10. Drain Current vs. Case Temperature

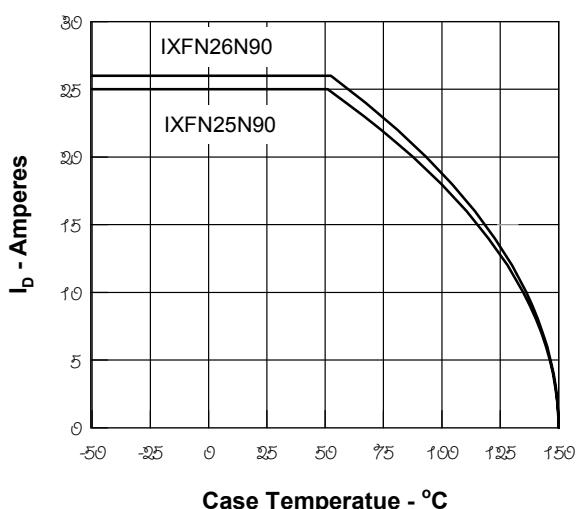


Figure 11. Transient Thermal Resistance

